Messrs.						
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.	
Troduct Specification	IVIOUCI	111111C-50002ARGIIS-01	A.	August. 31. 17	1/29	

LIQUID CRYSTAL DISPLAY MODULE MODEL: NMTC-S0802XRGHS-01 Customer's No.:

Acceptance

Microtips Technology Inc. 12F. No.31 Lane 169, Kang Ning St., His-Chih, Taipei Hsien, Taiwan, R.O.C. FAX: 886-2-26958625

Approved and Checked by							

Approved by	Check	Made by	
微端	微端	微 端	微端 2017/08/31 許瓊窈
2017/08/31	2017/08/31	2017/08/31	
連俊傑	幸有乾	洪振益	



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	IVIOUCI	NW1C-30002ARG113-01	A.	August. 31. 17	2/29

Revise Records

Rev.	Date	Contents	Written	Approved
A.	2017/08/31	See Note 1.	Jill Hsu	Danny Lien

Special Notes

Note 1.	The LCD module is compliant with RoHS.
Note 2.	
Note 3.	
Note 4.	
Note 5.	
Note 6.	



Messrs.						
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.	
	IVIOUCI	101011C-50002ARG115-01	\overline{A} .	August. 31. 17	3 / 29	

CONTENTS

ITEM	PAGE
FEATURES	5.
GENERAL SPECIFICATION	6.
ABSOLUTE MAXIMUM RATING	6.
ELECTRICAL CHARACTERISTICS	7.
OPTICAL CHARACTERISTICS	7.
MECHANICAL SPECIFICATION	8.
INTERFACE PIN ASSIGNMENT	9.
BLOCK DIAGRAM	12.
POWER SUPPLY DIAGRAM	12.
TIMING CHARACTERISTICS	13.
READ / WRITE TIMING CHART	14.
COMMANDS	15.
COMMANDS DESCRIPTION	16.
DD RAM ADDRESSING	20.
CG RAM MAPPING	22.
CHARACTER FONT TABLE	23.



Messrs.						
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.	
1 Todact Specification	WIOUCI	111111C-50002ARG115-01	A.	August. 31. 17	4/29	

ITEM	PAGE
RELIABILITY TEST	24.
APPEARANCE CHECK	24.
HANDLING PRECAUTIONS	25
LCD PRODUCT QUALITY STANDARD	26.
WARRANTY	28.
DIMENSIONAL OUTLINES	29.



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	MIOUCI	111111C-50002ARG115-01	A.	August. 31. 17	5 / 29

FEATURES of

LIQUID CRYSTAL DISPLAY MODULE

MODEL NO.: <u>NMTC-S0802XRGHS-01</u>

Character Type Dot Matrix LCD Module

Easy interface of 4 – bit or 8 – bit

Display character pattern: 5×7 font with cursor (208 kinds)

The special character pattern can be programmable by Character Generator RAM directly.

A customer character pattern can be programmable by mask option.

Automatically power on reset.

Internal Memory:

- Character Generator ROM (CGROM): 10,080 bits (204 characters × 5 × 8 dot)
- Character Generator RAM (CGRAM): 64 × 8 bits (8 characters × 5 × 8 dot)

Low power operation:

- Power supply voltage range: $2.7 \sim 5.5 \text{ V (V}_{DD})$
- LCD drive voltage range: $3.0 \sim 13.0 \text{ V} (V_{DD} \text{Vo})$

Low power consumption

CMOS process Duty – cycle: 1/16

View Direction	☑ 6 O'clock				□ 12 O'clock					
LCD True	□ FSTN P	ositive				☐ FSTN Negative				
LCD Type	☑ STN Gra	ay	\square S	TN	Yellow	Green			STN B	lue
Rear Polarizer	☑ Reflecti	ve	ПТ	rans	sflective				Transn	nissive
Backlight Type	□ LED	□ EL			☐ Internal Power				□ 5V input	
Backlight Type	□ LED		FL		☐ External Power				□ 12V input	
Backlight Color	☐ White		Ambe	r	□ Blue Green			Yellow Green □ Other		□ Other
Temperature Range	□ Normal			☑ Wide			Super	Wide		
CCFL Inverter	□ Build – in			☑ Not Build – in						
EL Driver IC	□ Build – in			☑ Not Build – in						
Touch Screen	□ With			√	☑ Without					

TO BE VERY CAREFUL!

The LCD driver ICs are made of CMOS process, which is very easy to be damaged by static charge, make sure the user is grounded when handling the LCM.



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
1 Todact Specification	IVIOUCI	111111C-50002ARG115-01	A.	August. 31. 17	6/29

GENERAL SPECIFICATION

Item	Content
Display Resolution	8 Characters × 2 lines
Dimensional Outline (mm)	$58.0 \text{ (W)} \times 32.0 \text{ (H)} \times 9.2 \text{ max (D)}$
Display mode	Reflective / Positive Type
Circuit	Controller IC, Segment – driver IC
Interface	Data (DB0~DB7), RS, R/W, E

ABSOLUTE MAXIMUM RATING

(1) Electrical Absolute Ratings

Item	Symbol	Min.	Max.	Unit	Note
Power Supply for Logic	$V_{DD} - V_{SS}$	-0.3	7.0	Volt	
Power Supply for LCD	V_{DD} – Vo	0	15.0	Volt	
Input Voltage	V _{IN}	-0.3	V _{DD} +0.3	Volt	
Supplier current for LED backlight	I_{LED}		140	mA	1

Note: Operator should be grounded during handling LCM.

(2) Environmental Absolute Maximum Ratings

	1	Normal Te	emperatur	e	Wide Temperature			
Item	Operating		Operating Storage		Operating		Storage	
	Max,	Min.	Max, Min.		Max,	Min.	Max,	Min.
Ambient Temperature	0°℃	+50°C	-20°C	+70°C	-20°C	+70°C	-30°C	+80°C
Humidity (without condensation)	Note 2,4		Note 3,5		Note 4,5		Note 4,6	

Note 2: Ta≤50°C: 80% RH max

Ta $> 50^{\circ}$ C: Absolute humidity must be lower than the humidity of 85% RH at 50°C

Note 3: Ta at -20° C will be < 48hrs at 70° C will be < 120hrs

Note 4: Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note 5: $Ta \le 70^{\circ}C$: 75RH max

Ta > 70° C: absolute humidity must be lower than the humidity of 75% RH at 70° C

Note 6: Ta at -30° C will be < 48hrs, at 80° C will be < 120hrs



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
1 roduct Specification	Wiodei	NWITC-50002ARGII5-01	<i>A</i> .	August. 31. 17	7/29

ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply for Logic	$V_{DD} - V_{SS}$	1	2.7	4.5	5.5	Volt
Innut Valtaga	$V_{ m IL}$	L level	$ m V_{SS}$	$0.2~V_{DD}$		Volt
Input Voltage	$ m V_{IH}$	H level	$0.8\;V_{DD}$	$V_{ m DD}$		Volt
LCM		$Ta = 20^{\circ}C$	4.48	4.78	5.08	
Recommend LCD Module	$V_{DD} - V_{OD}$ = 4.4	Ta = 25°C	4.20	4.50	4.80	Volt
Driving Voltage		$Ta = 70^{\circ}C$	3.92	4.22	4.52	
Power Supply	I _{DD} * (B/L OFF)	$V_{DD} = 4.5V$ $V_{DD} - V_{O} = 4.4V$	1	1.5	2.0	A
Current for LCM	I_{LED}	$V_{LED} = 4.2V$ $Ta = 25^{\circ}C$		70	105	mA

^{*}I_{DD} including current for logic circuit and LCD panel

OPTICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Тур	Max.	Unit	note	
	Φf (12 o'clock)			40				
Viewing Angle	Φb (6 o'clock)	When Cr≥2		45		Degree	9, 10	
Range	Ф1 (9 o'clock)	when Ci ≤ 2		40				
	Φr (3 o'clock)			40				
Rise Time	T_{r}	V _{DD} – Vo		90	230	m C		
Fall Time	$T_{ m f}$	=4.4V		160	240	mS		
Contrast	Cr	Ta = 25°C	2	7			7	



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Wiodei	NW1C-50002/RG115-01	A.	August. 31. 17	8/29

MECHANICAL SPECIFICATION

Product No.		NMTC – S0802XRGHS-01			
Module Size		$58.0 \text{ (W)} \text{ mm} \times 32.0 \text{ (H)} \text{ mm} \times 9.2 \text{ (D)} \text{ mm Max}$			
Display Format		8 characters × 2 lines			
Character Size		2.96 mm × 5.56 mm			
Character Pitch		3.55 mm × 5.94 mm			
Dot Size		0.56 (W) mm × 0.66 (H) mm			
Dot Pitch		0.60 (W) mm × 0.70 (H) mm			
Duty Ratio		1/16 Duty			
Character Font Table		☑English □European □Other			
	STN	☑Gray Mode ☐Yellow Mode ☐Blue Mode			
LCD Display Mode	FSTN	☐ Black & White (Normally White / Positive Image) ☐ Black & White (Normally White / Negative Image)			
	Rear Polarizer	☑ Reflective ☐ Transflective ☐ Transmissive			
Viewing Direction		☑6 O'clock □12 O'clock □3 O'clock □9 O'clock			
Backlight		☑Without □CCFL □EL □LED			
Controller		ST 7066			
DC/DC Converter		Without			
CCFL Inverter		Without			
EL Driver		Without			

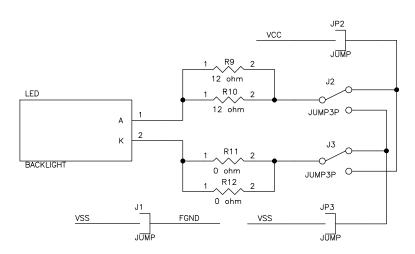


Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
1 roduct Specification	IVIOUCI	111111 C-50002ARG115-01	A.	August. 31. 17	9/29

INTERFACE PIN ASSIGNMENT

PIN NO.	PIN OUT	DESCRIPTION			
1.	V_{SS}	Ground			
2.	$ m V_{DD}$	Logic Circuit Power Supply			
3.	Vo	Power Supply For LCD Panel			
4.	RS	Data / Instruction Register Select			
5.	R/W	Read / Write Select			
6.	Е	Enable Signal			
7.	DB0				
8.	DB1				
9.	DB2				
10.	DB3	3 – State I/O Data Bus			
11.	DB4	5 – State 1/0 Data Bus			
12.	DB5				
13.	DB6				
14.	DB7				

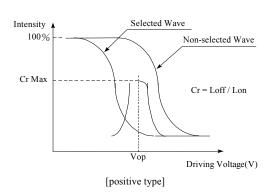
Schematic and Jumper Explanation for LED backlight:

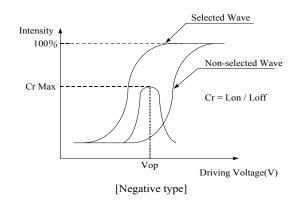




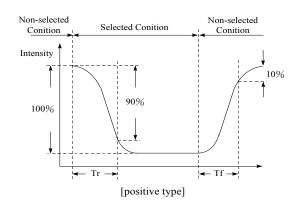
Messrs.									
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.				
Troduct Specification	IVIOUCI	111111C-50002ARGIIS-01	A.	August. 31. 17	10/29				

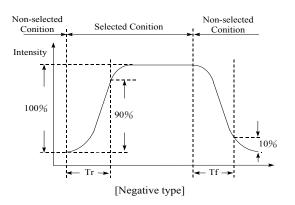
[Note 7] Definition of Operation Voltage (Vop)





[Note 8] Definition of Response Time (Tr, Tf)



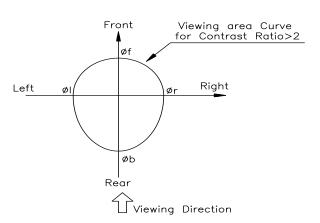


Conditions:

Operating Voltage: Vop Frame Frequency: 64 Hz

Viewing Angle (θ , φ): 0°, 0° Driving Wave form: 1/N duty, 1/a bias

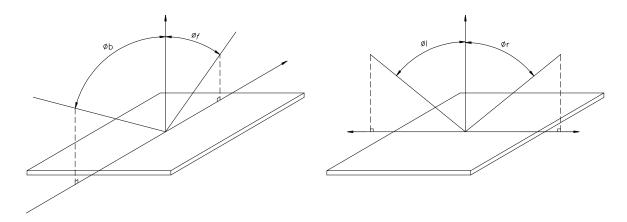
[Note 9] Definition of Viewing Direction



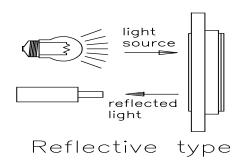


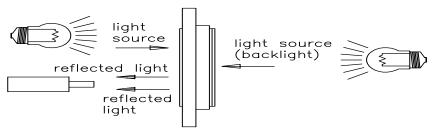
Messrs.									
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.				
Troduct Specification	IVIOUCI	1 1 1 1 1 C-50002 AROTTS-01	A.	August. 31. 17	11 / 29				

[Note 10] Definition of viewing angle



[Note 11] Description of Measuring Equipment



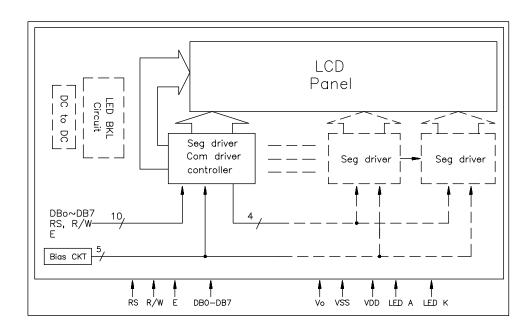


Transflective type

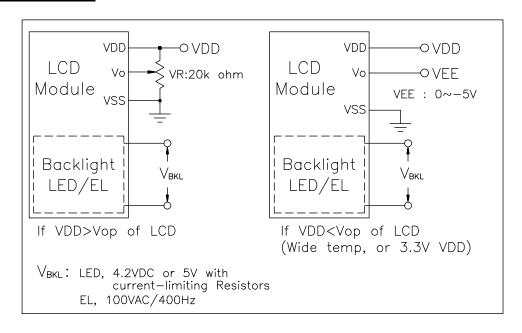


Messrs.									
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.				
Troduct Specification	IVIOUCI	111111C-50002ARGIIS-01	A.	August. 31. 17	12/29				

BLOCK DIAGRAM



POWER SUPPLY





Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Wiodei	NW1C-50002ARG115-01	<i>A</i> .	August. 31. 17	13 / 29

TIMING CHARACTERISTICS

AC Characteristics ($V_{SS} = 0V$, $V_{DD} = 4.5V$ to 5.0V, Ta = 0to $50^{\circ}C$)

Mode	Characteristic	Symbol	Min.	Typ.	Max.	Unit
	E Cycle Time	$t_{\rm C}$	500	1	1	ns
<u>o</u>	E Rise / Fall Time	t_R, t_F	1	1	20	ns
Tod	E Pulse Width (High, Low)	$t_{ m W}$	230	ŀ	ŀ	ns
Write Mode	R/W And RS Setup Time	$t_{ m SU1}$	40	ŀ	ŀ	ns
Vrit	R/W And RS Hold Time	$t_{\rm H1}$	10	1	1	ns
	Data Setup Time	$t_{ m SU2}$	80			ns
	Data Hold Time	t_{H2}	10			ns
	E Cycle Time	$t_{\rm C}$	500			ns
o	E Rise / Fall Time	t_R, t_F			20	ns
lod	E Pulse Width (High, Low)	$t_{ m W}$	230			ns
d N	R/W And RS Setup Time	$t_{ m SU}$	40			ns
Read Mode	R/W And RS Hold Time	t_{H}	10			ns
12	Data Setup Time	t_{D}			120	ns
	Data Hold Time	$t_{ m DH}$	5			ns

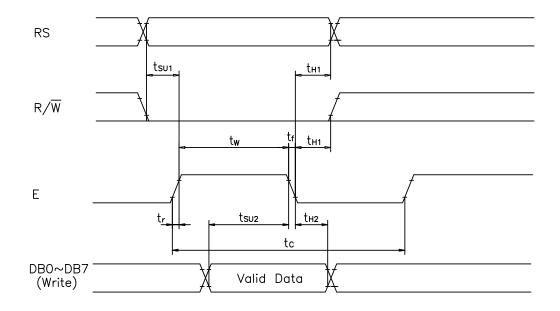
AC Characteristics (V_{SS} = 0V, V_{DD} = 2.7V to 4.5V, Ta = 0 to 50°C)

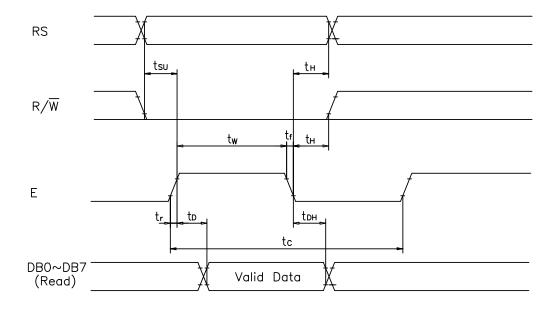
Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit
	E Cycle Time	$t_{\rm C}$	1000	1	1	ns
<u>e</u>	E Rise / Fall Time	t_R, t_F		1	25	ns
4oć	E Pulse Width (High, Low)	$t_{ m W}$	450	1	1	ns
Write Mode	R/W And RS Setup Time	$t_{ m SU1}$	60	1	1	ns
Vrit	R/W And RS Hold Time	$t_{\rm H1}$	20	1	-	ns
>	Data Setup Time	$t_{ m SU2}$	195	1	ŀ	ns
	Data Hold Time	t_{H2}	10			ns
	E Cycle Time	$t_{\rm C}$	1000			ns
co.	E Rise / Fall Time	t_R, t_F			25	ns
lod	E Pulse Width (High, Low)	$t_{ m W}$	450	-	-	ns
d N	R/W And RS Setup Time	$t_{ m SU}$	60	1	-	ns
Read Mode	R/W And RS Hold Time	t_{H}	20	1	-	ns
<u> </u>	Data Setup Time	t_{D}			360	ns
	Data Hold Time	t_{DH}	5			ns



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
1 roduct Specification	IVIOUCI	111111 C-50002ARG115-01	\overline{A} .	August. 31. 17	14/29

READ / WRITE TIMING CHART







Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Model	NW1C-50002ARG115-01	A.	August. 31. 17	15 / 29

COMMANDS

		ı		Ins	tructi	on Co	ode		ı	ı		Execution
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	time (f _{OSC} is 270kHz)
Clear Display	0	0	0	0	0 0 0 0 0 Write "20H" to DDRAM. and set DDRAM address to "00H" from AC							
Return Home	0	0	0	0 0 0 0 0 0 from AC and return cursoriginal position if shifted contents of DDRAM are		Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53mS					
Entry Mode	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and make shift of entire display enable.	39 μS
Display ON/OFF	0	0	0	0	0	0	1	D	С	Set display (D), cursor (C), a		39 μS
Cursor or Display Shift	0	0	0	0	0 0 1 S/C R/L * Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.		39 μS					
Function Set	0	0	0	0	1	DL	N	F	*	*	Set interface data length (DL: 4-bit / 8-bit), numbers of display line (N: 1-line / 2-line), display font type(F: 5 X 8 dots / 5 X 11 dots)	39 μS
Set CG RAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μS
Set DD RAM Address	AM 0		1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39 μS
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μS
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM / CGRAM).	43 μS
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM / CGRAM).	43 μS

^{*} means don't care



Messrs.									
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.				
Troduct Specification	IVIOUCI	111111C-50002ARGIIS-01	A.	August. 31. 17	16/29				

COMMANDS DESCRIPTION

Clear Display

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	0	1

Clear all the display data by writing "20H" (space code) to all DDRAM address, and set DDRAM address to "00H" into AC (address counter). Return cursor to the original status. namely, bring the cursor to the left edge on first line of the display. Make entry mode increment (I/D = "1").

Return Home

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	0	1	*

Return Home is cursor return home instruction. Set DDRAM address to "00H" into the address counter. Return cursor to its original site and return display to its original status, if shifted. Content of DDRAM is not changed.

Entry Mode Set

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	0	1	I/D	SH

Set the moving direction of cursor and display.

I/D: Increment / decrement of DDRAM address (cursor or blink)

When I/D = "High", cursor / blink moves to right and DDRAM address is increased by 1.

When I/D = "Low", cursor / blink moves to left and DDRAM address is decreased by 1.

SH: Shift of entire display

When DDRAM read (CGRAM read / write) operation or SH = "Low", shift of entire display is not performed. If SH = "High" and DDRAM write operation, shift of entire display is performed according to I/D value (I/D = "1", shift left, I/D = "0": shift right).



^{*} CGRAM operates the same as DDRAM, when read from or write to CGRAM.

Messrs.										
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.					
1 roduct Specification	Wiodei	111111C-30002ARG113-01	<i>A</i> .	August. 31. 17	17 / 29					

Display ON/OFF Control

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	0	1	D	С	В

Control display / cursor / blink ON/OFF 1 bit register.

D: Display ON/OFF control bit

When D = "High", entire display is turned on.

When D = "Low", display is turned off, but display data is remained in DDRAM.

C: Cursor ON/OFF control bit

When C = "High", cursor is turned on.

When C = "Low", cursor is disappeared in current display, but I/D register remains its data.

B: Cursor Blink ON/OFF control bit

When B = "High", cursor blink is on, that performs alternate between all the high data and display character at the cursor position.

When B = "Low", blink is off.

Cursor or Display Shift

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	0	1	S/C	R/L	*	*

Without writing or reading of display data, shift right / left cursor position or display.

This instruction is used to correct or search display data. (Refer to Table 4)

During 2 – line mode display, cursor moves to the 2nd line after 40th digit of 1st line.

Note that display shift is performed simultaneously in all the line.

When displayed data is shifted repeatedly, each line shifted individually.

When display shift is performed, the contents of address counter are not changed.

S/C	R/L	Operation		
0	0	Shift cursor to the left, AC is decreased by 1.		
0 1 Shift cursor to the right, AC is increased by 1.				
1		Shift all of the display to the left, cursor moves according to the display.		
1		Shift all of the display to the right, cursor moves according to the display.		



Messrs.										
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.					
Troduct Specification	IVIOUCI	111111C-50002ARG115-01	\overline{A} .	August. 31. 17	18/29					

Function Set

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
00	0	0	0	1	DL	N	F	*	*

DL: Interface data length control bit

When DL = "High", it means 8 - bit bus mode with MPU.

When DL = "Low", it means 4 – bit bus mode with MPU. So to speak, DL is a signal to select 8 – bit or 4 – bit bus mode. When 4 – bit bus mode, it needs to transfer 4 – bit data by two times.

N: Display line number control bit

When N = "Low", it means 1 - line display mode.

When N = "High", 2 - line display mode is set.

F: Display font type control bit

When F = "Low", it means 5 X 8 dots format display mode

When F = "High", 5 x11 dots format display mode.

Set CG RAM Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Set CGRAM address to AC.

This instruction makes CGRAM data available from MPU.

Set DD RAM Address

	R/W								
0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0

Set DDRAM address to AC.

This instruction makes DDRAM data available from MPU.

When 1 - line display mode (N = 0), DDRAM address is from "00H" to "4FH".

In 2 – line display mode (N = 1), DDRAM address in the 1st line is from "00H" to "27H", and DDRAM address in the 2nd line is from "40H" to "67H".



Messrs.										
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.					
Troduct Specification	IVIOUCI	1 1 1 1 1 C-50002 ARG 115-01	\overline{A} .	August. 31. 17	19/29					

Read Busy Flag and Address

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0

This instruction shows whether ST 7066 is in internal operation or not. If the resultant BF is High, it means the internal operation is in progress and you have to wait until BF to be Low, and then the next instruction can be performed. In this instruction you can read also the value of address counter

Write Data to RAM

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write binary 8 – bit data to DDRAM / CGRAM.

The selection of RAM from DDRAM, CGRAM, is set by the previous address set instruction: DDRAM address set, CGRAM address set. RAM set instruction can also determine the AC direction to RAM. After write operation, the address is automatically increased / decreased by 1, according to the entry mode.

Read Data to RAM

_	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
	1	0	D7	D6	D5	D4	D3	D2	D1	D0

Read binary 8 – bit data from DDRAM / CGRAM.

The selection of RAM is set by the previous address set instruction. If address set instruction of RAM is not performed before this instruction, the data that read first is invalid, because the direction of AC is not determined. If you read RAM data several times without RAM address set instruction before read operation, you can get correct RAM data from the second, but the first data would be incorrect, because there is no time margin to transfer RAM data.

In case of DDRAM read operation, cursor shift instruction plays the same role as DDRAM address set instruction: it also transfers RAM data to output data register. After read operation address counter is automatically increased / decreased by 1 according to the entry mode. After CGRAM read operation, display shift may not be executed correctly.

NOTE: In case of RAM write operation, after this AC is increased / decreased by 1 like read operation. In this time, AC indicates the next address position, but you can read only the previous data by read instruction.



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Wiodei	11W11C-50002ARG115-01	A.	August. 31. 17	20 / 29

DD RAM ADDRESSING

For 16×1 or 8×1 Display

Character DD RAM Address

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
-	00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

For 16×2 or 8×2 Display

Character DD RAM Address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F

For 16 × 4 Display

Character

DD RAM Address

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
00	01	02	03	04	05	06	07	08	09	0A	0B	0C	0D	0E	0F
40	41	42	43	44	45	46	47	48	49	4A	4B	4C	4D	4E	4F
10	11	12	13	14	15	16	17	18	19	1A	1B	1C	1D	1E	1F
50	51	52	53	54	55	56	57	58	59	5A	5B	5C	5D	5E	5F

For 20 × 2 Display

Character DD RAM Address

1		2	3	4	5	6	7	8	9	10	 	17	18	19	20
00)	01	02	03	04	05	06	07	08	09	 	10	11	12	13
40)	41	42	43	44	45	46	47	48	49	 	50	51	52	53



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Wiodei	11W11C-50002ARG115-01	A.	August. 31. 17	21 / 29

For 20 × 4 Display

Character

DD RAM Address

1	2	3	4	5	6	7	8	9	10	 	17	18	19	20
00	01	02	03	04	05	06	07	08	09	 	10	11	12	13
40	41	42	43	44	45	46	47	48	49	 	50	51	52	53
14	15	16	17	18	19	1A	1B	1C	1D	 	24	25	26	27
54	55	56	57	58	59	5A	5B	5C	5D	 	64	65	66	67

For 40×2 Display

Character DD RAM Address

1	2	3	4	5	6	7	8	9	10	 	37	38	39	40
00	01	02	03	04	05	06	07	08	09	 	24	25	26	27
40	41	42	43	44	45	46	47	48	49	 	64	65	66	67

For 40 × 4 Display

Character

DD RAM Address

Е	1	2	3	4	5	6	7	8	9	10	 	37	38	39	40
E1	00	01	02	03	04	05	06	07	08	09	 	24	25	26	27
EI	40	41	42	43	44	45	46	47	48	49	 	64	65	66	67
E3	00	01	02	03	04	05	06	07	08	09	 	24	25	26	27
E2	40	41	42	43	44	45	46	47	48	49	 	64	65	66	67



Messrs.					
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.
Troduct Specification	Wiodei	NW1C-50002ARG115-01	A.	August. 31. 17	22 / 29

CG RAM MAPPING

					Cod data				C	G R	AM.	I Ac	ddre	ess					icte:					
7 Hig	6	5	4	3	2	1	0 .ow		5 Hig	4 gh	3	2	1 L	0 Low		7 Hig	6	5	4	3	2	1	0 .ow	
0	0	0	0	*	0	0	0		0	0	0	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0		*	*	*	0 1 0 0 1 0 0 0	1 0 0 1 1 0 0 0	1 0 1 0 1 0 0 0	0 1 0 0 1 0 0 0	0 0 0 0 0 0 0 0	←Character Pattern ←Cursor
0	0	0	0	*	0	0	1		0	0	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0		*	*	*	1 1 1 1 1 1 1 0	1 0 0 0 0 0 1	1 0 1 1 1 0 1	0 0 1 0 0 1 0	1 1 1 1 1 1 1 0	←Character Pattern ←Cursor
	:						:	:	:	:	:	:	:	:	:	:	:	:				:		
0	0	0	0	*	1	1	1		1	1	1	0 0 0 0 1 1 1	0 0 1 1 0 0 1 1	0 1 0 1 0 1 0 1		*	*	*	1 1 1 1 1 1 1 0	1 0 1 0 0 0 1	1 0 1 0 1 0 1 0	1 0 0 0 1 0 1	1 1 1 1 1 1 0	←Character Pattern ←Cursor



Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
1 Todact Specification	IVIOUCI	1 1 1 1 1 C-50002 AROHS-01	A.	August. 31. 17	23 / 29			

CHARACTER FONT TABLE

Upper Lower 4 bits	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)						*•	F					-33	==_		
0001	CG RAM (2)			1.			-===	-==					;		-==	
0010	CG RAM (3)							! -			!	• †	ij	,×*		₿
0011	CG RAM (4)		#	<u></u>		=====	=	= -			!	-		===	===-	==-==
0100	CG RAM (5)		:	4				ŧ.			•-		 -	†=	 	<u>=</u>
0101	CG RAM (6)		##* *#				====	! !			==		;		=	<u></u>
0110	CG RAM (7)					II	₽.	I.,.I				17			=	===
0111	CG RAM (8)		:	•			===	إبإ					:::		==	JI
1000	CG RAM (1)		<	8		×	 -	×			- - [-‡ -	•••	=	==
1001	CG RAM (2)		>	•==	I	¥	i	•===				' T	,i	I L	1	<u></u>
1010	CG RAM (3)		:	==			i						1	<u>.</u>		====
1011	CG RAM (4)			::	K		K	€			;:	#			2-2] ==
1100	CG RAM (5)		:	•				i			† :	= :		" ,"	===-	
1101	CG RAM (6)						m	}				<u>.~</u> .	••••		≢	
1110	CG RAM (7)		==			.·*	! -":							"-	===	
1111	CG RAM (8)			•			====	-			• :•	L. !	:			



Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
Troduct Specification	Model	NW1C-50602ARG115-01	\overline{A} .	August. 31. 17	24 / 29			

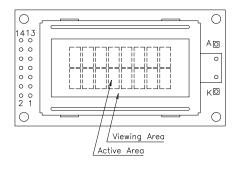
RELIABILITY TEST

No	Item	Conditions		Note
1.	High Temp. Operation	70°C	240 Hr	
2.	High Temp. Storage	80°C	240 Hr	
3.	Low Temp. Operation	-20°C	240 Hr	
4.	Low Temp. Storage	-30°C	240 Hr	
5.	High Temp. / Humid Storage	60°C 95% RH	240 Hr	
6.	Thermal Shock	-20°C, 120min -60°C, 120min	10 cycles	
7.	Vibration Test (IEC – 68 – 2 – 6)	Frequency: 10 ~ 55 Hz Duration: 20 times, 6 min / time Amplitude: 0.75 mm		
8.	Shock (IEC 68 – 2 – 27)	Duration: 11 mS Acceleration: 100g		X, Y, Z direction

APPEARANCE CHECK

CONDIITON OF APPEARANCE CHECK:

- (1)Specimen shall be checked by eyes in distance of 30cm under 40w fluorescence lamp.
- (2) Checking direction shall be in 45 degree from perpendicular line op specimen surface.





Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
Product Specification	Model	1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\	A.	August. 31. 17	25 / 29			

HANDLING PRECAUTIONS

- (1) Treat polarizer very carefully since it is easy to be damaged.
- (2) When cleaning the display surface, use soft cloth (e.g. gauss) with a solvent (recommended below) and wipe lightly.
 - ethyl alcohol
 - ♦ iso prcolol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvents:

- water
- **▶** ketone
- aromatics
- (3) Direct current causes electro chemical reaction with remarkable degradation of the display quality. Give careful consideration to prevent direct current at ON/OFF timing and during operation.
- (4) Avoid strong shock and drop from the height.
- (5)To prevent LCD panels from degradation, do not operate or store them exposed directly to sunshine or high temperature / humidity.
- (6) Give careful consideration to avoid electrical static discharge with causes uneven contrast.
- (7)Even a small condensation on the contact pads (terminals) causes electro chemical reaction which makes missing row and column. Give careful attention to avoid condensation. When assembling with zebra connector, clean the surface of the pads with alcohol and keep the air very clean.



Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
1 roduct Specification	Wiodei	111111C-30002ARG113-01	<i>A</i> .	August. 31. 17	26 / 29			

LCD PRODUCT QUALITY STANDARD

Display appearance

No	Item		Criteria	ispiay appearance		
110	HOIII	(1) 7	Cittoria			
1.	Inclusions (Black spot, white spot, dust)	(1)Round type Diameter mm (a*) $a \le 0.20$ $0.20 < a \le 0.35$ $0.35 < a$ (2)Linear type Length mm (1)	no of defect* neglect 5max none width mm (W)	no. of defect		
		na	$W \leq 0.03$	neglect		
		1≦3	$0.03 < W \le 0.08$	6		
		3<1	0.08 < W	none		
2.	Scratch	1. Scratch on protective film is permitted. 2. Scratch on polarizer shall be as follow: (1)Round type Diameter mm (a*) no of defect a≤0.15 neglect 0.15 < a≤0.20 2 max 0.20 < a none (2)Linear type be judged bye 1(2) linear type				
3.	Dent	Diameter < 1.5mm				
4.	Bubble	Not exceeding 0.5mm glass and polarizing fil	average diameter is accomm	eptable between		
5.	Pin hole	$(a + b)/2 \le 0.15$ mm maximum number: ign $0.15 < (a + b)/2 \le 0.20$ maximum number: 10				



Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
1 Todact Specification	IVIOUCI	NW1C-50602ARG115-01	A.	August. 31. 17	27 / 29			

No	Item	Criteria					
6.	Dot defect	$(a + b)/2 \le 0.20$ mm maximum number: ignored $0.20 < (a + b)/2 \le 0.30$ mm maximum number: 5 x = width					
7.	Contrast irregularity (Spot)	$\begin{array}{lll} \text{Diameter spec} & \text{no of defect} \\ a \leq 0.50 \text{mm} & \text{neglect} \\ 0.50 & < a \leq 0.75 & 5 \\ 0.75 & < a \leq 1.00 & 3 \\ 1.00 & < a & \text{none} \end{array}$					
8.	Dot width	Design width ± 15%					
9.	Color tone and uniformity	Obvious uneven color is not permitted.					



Messrs.								
Product Specification	Model	NMTC-S0802XRGHS-01	Rev. No.	Issued Date.	Page.			
Froduct Specification	Model	1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\1\	\overline{A} .	August. 31. 17	28 / 29			

WARRANTY

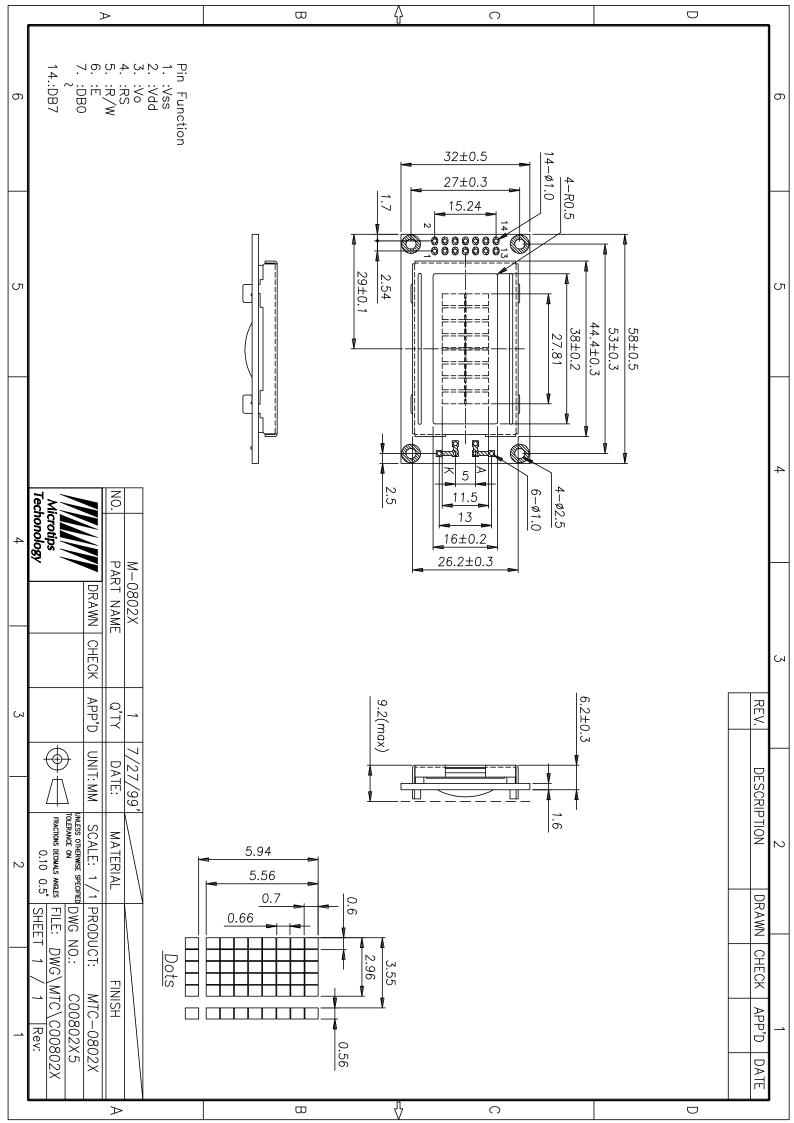
This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1 13 months guarantee starts from the date code.
- 2 We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 3 We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 4 We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- We cannot accept responsibility for industrial property, which may arise through the use of your product, with exception to those issues relating directly to the structure or method of manufacturing of our product. Microtips-origin longer than one year from Microtips production.

DIMENSIONAL OUTLINES

• See the next page......





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microtips Technology: NMTC-S0802XRGHS-01